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STRUCTURE Silicon Monolithic Integrated Circuit

TYPE BDE1204G

PRODUCT Thermostat and Analog Temperature Sensor

FEATURES 1) Highly accurate thermostat (  $\pm$  4.0°C )

2) Thermostat sensing temperature 115, 120, 125°C with CTRL state

3) Open drain output

4) Hysteresis temperature (TYP. 10°C)

5) Highly accurate analog output (  $\pm$  3.5°C@Ta = 30°C )

6) Analog output temperature sensitivity ( - 10.68 [ mV/°C ] )

7) Low supply current (TYP. 16.0uA)

8) Small package (TYP. 2.90mm× 2.80mm× 1.25mm)

#### • ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

PARAMETERS	SYMBOL	LIMIT	UNIT
Power Supply Voltage	$V_{DD}$	- 0.3 to 7.0*1	٧
Input Voltage ( CTRL )	$V_{IN}$	$-0.3$ to $V_{DD}+0.3$	٧
Input Current ( CTRL )	$I_{IN}$	- 1.0, +0.1	mA
OS terminal Voltage	Vos	- 0.3 to 7.0	٧
OS terminal Current	$I_{os}$	5.0	mΑ
Power dissipation	Pd	540 <sup>* 2</sup>	mW
Storage Temperature Range	T <sub>stg</sub>	- 55 to 150	°C

<sup>\*1.</sup> Not to exceed Pd

#### RECOMMENDED OPERATING CONDITION

PARAMETERS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Power Supply Voltage	VDD	2.9	3.0	5.5	٧
Operating Temperature Range	Topr	- 30	1	130	°C

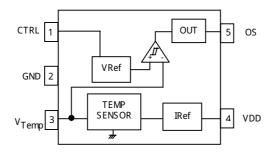
## • Status of this document

The J apanese version of this document is the formal specification. A customer may use this translation version only for a reference to help reading the formal version. If there are any difference in translation version of this document, formal version takes priority.

<sup>\*2.</sup> Reduced by 5.40mW for each increase in Ta of 1°C over 25°C (mounted on 70mm× 70mm× 1.6mm Glass-epoxy PCB )

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## BLOCK DIAGRAM



## PIN DESCRIPTION

PIN NO.	PIN NAME	FUNCTION	COMMENT		
1	CTRL	Sensing temperature setting	Refer to page 3/4 (TEMPERATURE / OUTPUT FORMAT TABLE) for the sensing temperature setting.		
2	GND	GROUND			
3	Vtemp	Output voltage in inverse proportion to the temperature ( TYP 10.68mV/°C )	Set the OPEN state or connect high impedance input node.		
4	VDD	POWER SUPPLY			
5	OS	Digital thermostat output	Open Drain type ( Active L ) Use the pull- up resistor more than $10k\Omega$ .		

## $\bullet~$ TEMPERATURE ACCURACY ( unless otherwise specified, V $_{DD}$ = 3.0V )

PARAMETER	SYMBOL	LIMIT			UNIT	CONDITIONS	
FARAIVILTER	STIVIDOL	MIN.	TYP.	MAX.	OINII	CONDITIONS	
Thermostat							
Sensing Temperature Accuracy	Tacc	-	0	± 4.0	°C	Ta = 115, 120, 125℃	
Sensing Temperature Hysteresis	Thys	7.5	10.0	12.5	$^{\circ}$		
Analog Output							
V <sub>Temp</sub> Temperature Accuracy	TTemp	-	-	± 3.5	°C	Ta = 30°C	

# • ELECTRICAL CHARACTERISTICS ( unless otherwise specified, $V_{DD}$ = 3.0V, Ta = 25°C )

PARAMETER	SYMBOL	MIN.	LIMIT TYP.	MAX.	UNIT	CONDITIONS			
Supply Current	Idd	-	16.0	20.0	uA	CTRL = 3.0V			
Analog Output									
V <sub>Temp</sub> Output Voltage	VTemp	1.716	1.753	1.790	V	Ta = 30°C			
V <sub>Temp</sub> Temperature Sensitivity	Vse	- 10.28	- 10.68	- 11.08	mV/°C	Ta = - 30 to 100°C			
V <sub>Temp</sub> Load Regulation	⊿VTempRL	1	-	1	mV	difference of Ιουτ : 0uA / 2uA			
OS Output Open Drain									
OS Leakage Current	IL	-	-	1.0	uA	OS: 5.0V			
OS Output Voltage	Vol	-	-	0.4	V	Iinos = 1.2mA			
CTRL									
Input L Voltage	VıL	GND	-	0.6	V				
Input H Voltage	VIH	2.4	-	VDD	V				

Radiation hardiness is not designed.

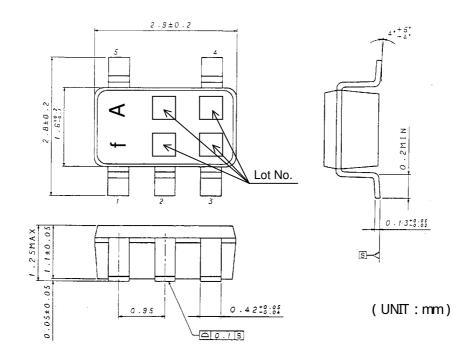
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## • BDE12040G TEMPERATURE / OUTPUT FORMAT TABLE

CTRL INPUT L: Low, O: Open, H: High

	TEMP	SENSING ERATURE	(°C )	OS Output				
TYPE		CTRL		FORMAT		MARKING		
	L	Н	0	1 OK				
BDE1204G	120	125	115	Open Drain	Active L	fA		

## • PACKAGE OUTLINES (SSOP5)



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#### • CAUTIONS ON USE

### 1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

#### 2) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state.

#### 3) Pin short and mistake fitting

When mounting the IC on the PCB, pay attention to the orientation of the IC. If there is a placement mistake, the IC may be burned up.

## 4) Operation in strong electric field

Be noted that using ICs in the strong electric field can malfunction them.

#### 5) Mutual impedance

Use short and wide wiring tracks for the power supply and ground to keep the mutual impedance as small as possible. Use a capacitor to keep ripple to a minimum.